



P R E S S R E L E A S E

X-FAB MEMS Foundry Wins “Foundry of the Year” Award at MEMS Executive Congress

***Honored for Best in MEMS and Sensors Innovation;
Named Runner-Up for “MEMS Supplier of the Year” Award***

ERFURT, Germany – November 20, 2014 – [X-FAB MEMS Foundry](#) today announced it received the “MEMS Foundry of the Year” award at the Best in MEMS & Sensors Innovation Awards ceremony, as part of the MEMS Industry Group’s 10th annual [MEMS Executive Congress®](#) held in Scottsdale, Arizona last week. X-FAB MEMS Foundry was chosen from among five finalists in an open voting process; it also was named runner-up in the “MEMS Supplier of the Year” category. The MEMS Industry Group is a trade association that advances MEMS and sensors across global markets.

X-FAB MEMS Foundry is part of the X-FAB group, a high-volume foundry service provider with five manufacturing facilities worldwide that manufacture MEMS, CMOS and SOI technologies on 150mm and 200mm platforms. MEMS devices include pressure sensors, micro-mirrors, microphones and microfluidic devices used in a wide variety of applications.

[Dr. Peter Merz](#), MEMS Business Unit Manager at X-FAB, said, “X-FAB is honored to receive the prized ‘MEMS Foundry of the Year’ award. We believe this achievement reflects the quality and excellence we deliver to our MEMS customers worldwide. Our commitment to enabling the commercialization of MEMS in the medical, automotive, consumer and mobile market sectors is demonstrated by our strong growth in MEMS revenues – 35-percent compound annual growth rate since 2010 – and the addition of two new MEMS fabs this year.”

MEMS devices manufactured by X-FAB can be either discrete or integrated with a range of leading analog/mixed-signal CMOS technologies down to 180 nanometers, leading to innovative solutions in terms of performance and form-factor. X-FAB offers both customer-specific processing and market-ready open-platform process technologies for pressure sensors, inertial sensors and thermopiles. It provides quick access to MEMS technologies and fast time to market for both small and large companies. MEMS customers seeking to integrate MEMS and CMOS on a single chip have direct access to X-FAB’s CMOS fabs.

About X-FAB

X-FAB is the leading analog/mixed-signal and MEMS foundry group manufacturing silicon wafers for automotive, industrial, consumer, medical and other applications. Its customers worldwide benefit from the highest quality standards, manufacturing excellence and innovative solutions by using X-FAB’s modular CMOS processes in geometries ranging from 1.0 to 0.18 μm , and its special BCD, SOI and MEMS long-lifetime processes. X-FAB’s analog-digital integrated circuits (mixed-signal ICs), sensors and micro-electro-mechanical systems (MEMS) are manufactured at five production facilities in Germany, Malaysia and the U.S. X-FAB employs 2,400 people worldwide. For more information, please visit www.xfab.com.

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Acronyms

BCD	Bipolar-CMOS-DMOS
CMOS	Complementary Metal Oxide Semiconductor
ICs	Integrated Circuits
MEMS	Microelectromechanical Systems
SOI	Silicon on Insulator

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